

General Description

This Trench MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for Back-light Inverter and power Supply.

FEATURES

- $V_{DSS}=40V$, $I_D=60A$.
- Low Drain to Source ON Resistance.
 - : $R_{DS(ON)}=8.5m\ \Omega$ (Max.) @ $V_{GS}=10V$
 - : $R_{DS(ON)}=11m\ \Omega$ (Max.) @ $V_{GS}=4.5V$
- Super High Dense Cell Design.
- High Power and Current Handling Capability.

MAXIMUM RATING (Ta=25 °C Unless otherwise Noted)

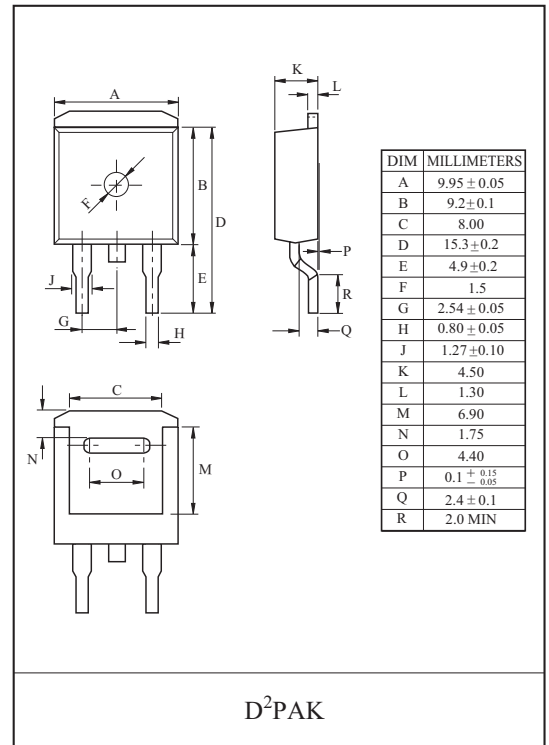
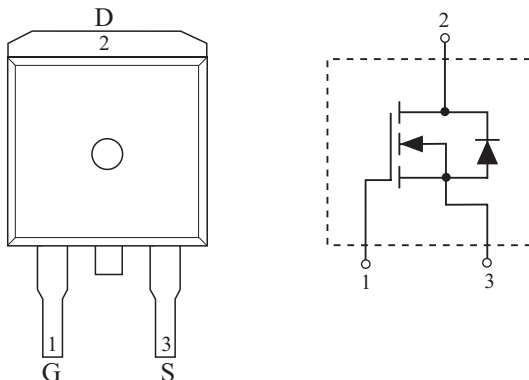
CHARACTERISTIC		SYMBOL	N-Ch	UNIT
Drain to Source Voltage		V_{DSS}	40	V
Gate to Source Voltage		V_{GSS}	± 20	V
Drain Current	DC@ $T_C=25\ ^\circ C$ (Note1)	I_D	60	A
	Pulsed (Note2)	I_{DP}	100	
Drain to Source Diode Forward Current		I_S	100	A
Single Pulsed Avalanche Energy (Note3)		E_{AS}	153	mJ
Drain Power Dissipation	@ $T_C=25\ ^\circ C$ (Note1)	P_D	69	W
	@ $T_a=25\ ^\circ C$ (Note2)		3.1	
Maximum Junction Temperature		T_j	150	$^\circ C$
Storage Temperature Range		T_{stg}	-55 ~ 150	$^\circ C$
Thermal Resistance, Junction to Case (Note1)		R_{thJC}	1.8	$^\circ C/W$
Thermal Resistance, Junction to Ambient (Note2)		R_{thJA}	40	$^\circ C/W$

Note 1) R_{thJC} means that the infinite heat sink is mounted.

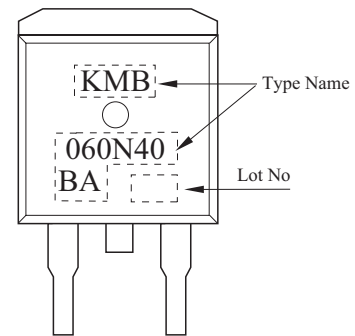
Note 2) Surface Mounted on 1 × 1 Pad of 2 oz copper.

Note 3) $L=42.5\ \mu H$, $I_{AS}=60A$, $V_{DD}=20V$, $V_{GS}=10V$, Starting $T_j=25\ ^\circ C$

PIN CONNECTION (TOP VIEW)



Marking



KMB060N40BA

ELECTRICAL CHARACTERISTICS (Ta=25 °C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static							
Drain to Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	40	-	-	V
Drain Cut-off Current		I _{DSS}	V _{GS} =0V, V _{DS} =24V	-	-	1	μA
Gate to Source Leakage Current		I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
Gate to Source Threshold Voltage		V _{th}	V _{DS} =V _{GS} , I _D =250μA	1	1.8	3	V
Drain to Source ON Resistance		R _{DS(ON)*}	V _{GS} =10V, I _D =14A (Note4)	-	5.7	8.5	mΩ
			V _{GS} =4.5V, I _D =11A (Note4)	-	7.5	11	
Forward Transconductance		g _{fs*}	V _{DS} =5V, I _D =14A (Note4)	-	58	-	S
Dynamic							
Input Capacitance		C _{iss}	V _{DS} =20V, f=1MHz, V _{GS} =0V	-	1280	-	pF
Output Capacitance		C _{oss}		-	250	-	
Reverse Transfer Capacitance		C _{rss}		-	125	-	
Gate Resistance		R _g	f=1MHz	-	1.5	-	Ω
Total Gate Charge		V _{GS} =10V	V _{DS} =20V, V _{GS} =10V, I _D =14A (Note4)	-	25.4	-	nC
		V _{GS} =5V		-	13.8	-	
Gate to Source Charge		Q _{gs*}		-	5.7	-	
Gate to Drain Charge		Q _{gd*}		-	5.4	-	
Turn-On Delay Time		t _{d(on)*}		V _{DD} =20V, V _{GS} =10V I _D =1A, R _G =6Ω (Note4)	-	16	
Turn-On Rise Time		t _{r*}	-		14	-	
Turn-Off Delay Time		t _{d(off)*}	-		55	-	
Turn-Off Fall Time		t _{f*}	-		14	-	
Source to Drain Diode Ratings							
Source to Drain Forward Voltage		V _{SD*}	V _{GS} =0V, I _S =14A (Note4)	-	0.8	1.2	V

Note 4) Pulse Test : Pulse width <300 μs , Duty cycle < 2%

KMB060N40BA

Fig1. $I_D - V_{DS}$

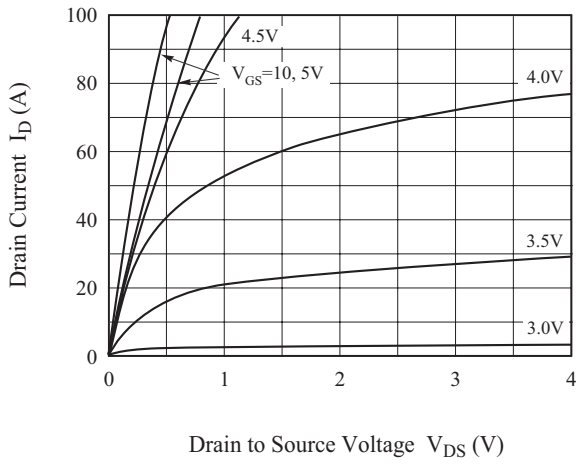


Fig2. $R_{DS(ON)} - I_D$

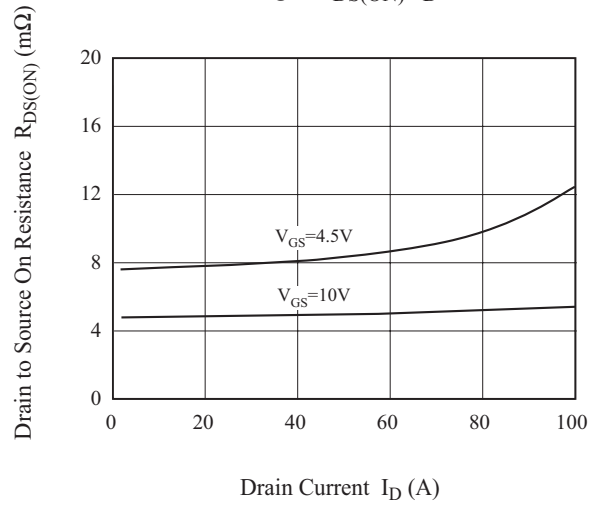


Fig3. $I_D - V_{GS}$

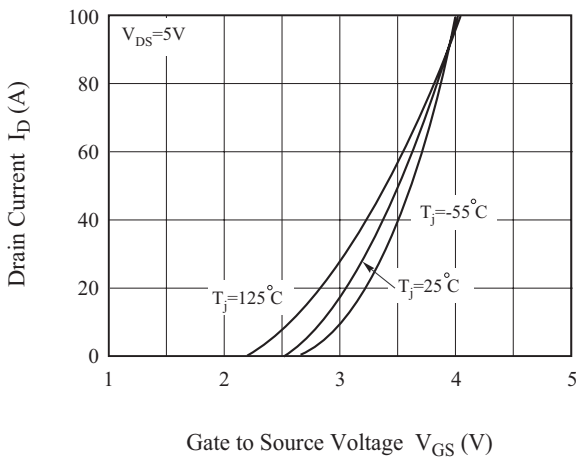


Fig4. $R_{DS(on)} - T_j$

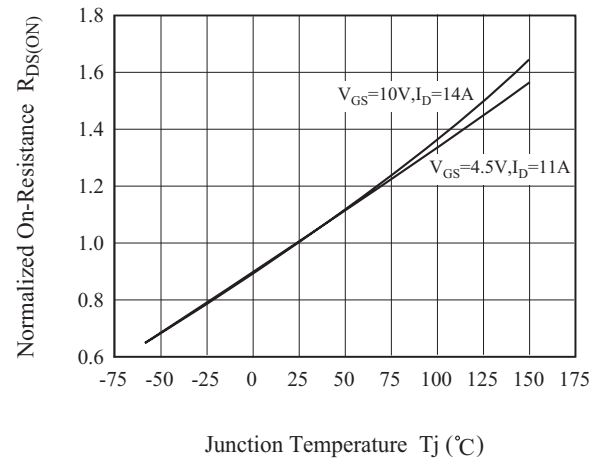


Fig5. $V_{th} - T_j$

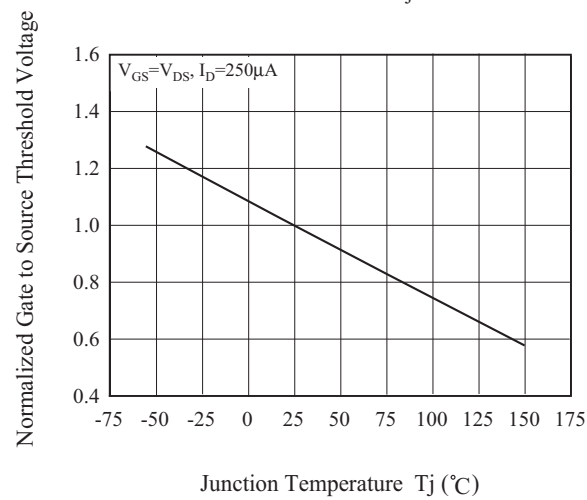
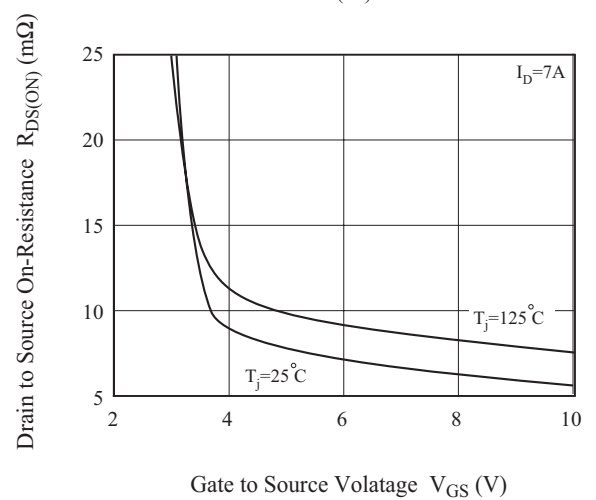


Fig6. $R_{DS(on)} - V_{GS}$



KMB060N40BA

Fig7. $I_D - V_{SD}$

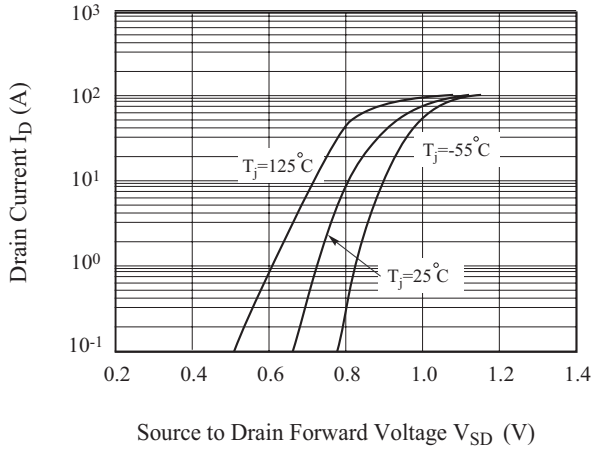


Fig 8. C - V_{DS}

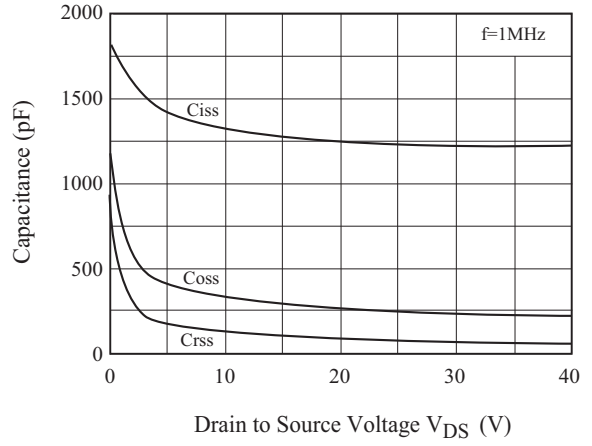


Fig9. Safe Operation Area

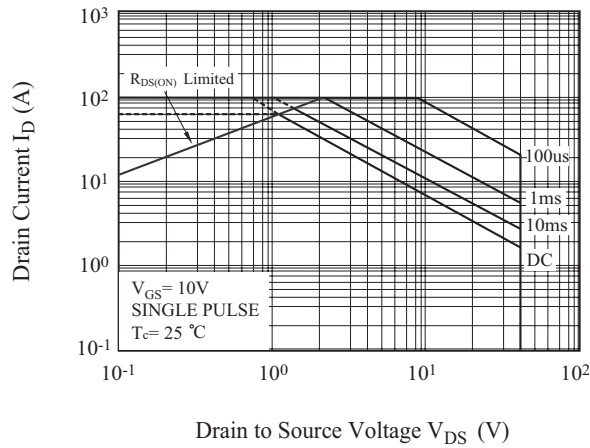


Fig10. Transient Thermal Response Curve

